

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT3355306

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUNHUI LOU	04/23/2015
HUA GONG	04/23/2015
JUNCHAO MA	04/23/2015
YONG WU	04/23/2015

RECEIVING PARTY DATA

Name:	SHANGHAI TIANMA MICRO-ELECTRONICS CO., LTD.
Street Address:	889 HUIQING RD.
Internal Address:	PUDONG NEW DISTRICT
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	201201
Name:	TIANMA MICRO-ELECTRONICS CO., LTD.
Street Address:	22/F, HANGDU BUILDING
Internal Address:	SHENNAN ROAD, FUTIAN DISTRICT
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518052

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14712188

CORRESPONDENCE DATA

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PATENT

ATTORNEY DOCKET NUMBER:	505685.000011
NAME OF SUBMITTER:	KELSEY DEHNE
SIGNATURE:	/kelseydehne/
DATE SIGNED:	05/15/2015
Total Attachments: 2 source=505685.000011#page1.tif source=505685.000011#page2.tif	

**COMBINED DECLARATION
& ASSIGNMENT**

Page 1 of 2

Title: ARRAY SUBSTRATE AND
MANUFACTURING METHOD THEREOF, AND
DISPLAY PANEL

ASSIGNMENT

WHEREAS, I, LOU, Junhui, GONG, Hua, MA, Junchao and WU, Yong have invented certain new and useful improvements as described in U.S. patent application, entitled ARRAY SUBSTRATE AND MANUFACTURING METHOD THEREOF, AND DISPLAY PANEL, the application having been executed on even date herewith, and/or being identified in the United States Patent and Trademark Office ("USPTO") by Application No. 14/712,188, filed May 14, 2015, ("Invention"); and

WHEREAS, Shanghai Tianma Micro-Electronics Co., Ltd., a Corporation of the Country of Peoples' Republic of China, and having an address of 889 Huiqing Rd., Pudong New District, Shanghai 201201, China; and Tianma Micro-Electronics Co., Ltd., a Corporation of the Country of Peoples' Republic of China, and having an address of 22/F, Hangdu Building, Shennan Road, Futian District, Shenzhen 518052, China (together with its successors and assigns, the "Assignee"), seeks to memorialize its ownership of the entire right, title and interest in and to the Invention;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, I transfer to Assignee my entire right, title, and interest in and to the Invention, including all inventions disclosed or claimed in the above-identified patent application, including any improvements thereof, any corresponding domestic applications (e.g., provisional, non-provisional, divisional, continuation, continuation-in-part, reexamination, and/or reissue patent), any corresponding foreign applications, all patents issuing thereon, or other patent application based off or claiming priority to the above-identified patent application, and all rights and benefits under any applicable treaty or convention. I authorize the USPTO (or foreign equivalent thereof) to issue any patent (or similar legal protection) to the Assignee.

I authorize the Assignee to insert in this instrument the filing date and application number of the application when ascertained. I hereby authorize the Assignee (or its designee) to apply for patent (or similar legal protection) in its own name if desired, in any and all countries.

I represent to the Assignee that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I agree when requested, without additional consideration, but at the expense of the Assignee, to provide additional reasonable assistance necessary to memorialize this assignment, to execute all oaths, declarations, assignments, powers of attorney and other papers necessary to perfect and vest title to the rights assigned herein to the Assignee; and will render all assistance in filing, obtaining, maintaining, and enforcing any patent (or similar legal protection) on the Invention in any and all countries.

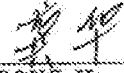
DECLARATION

I have reviewed and understand the contents of the above-identified patent application including the claims, and I believe I am an original or an original joint inventor of a claimed invention in the above-identified patent application. The above-identified patent application was made or authorized to be made by me. I am aware of and acknowledge my duty to disclose to the USPTO all information known to me to be material to patentability of the claims in the above-identified patent application. I acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.



LOU, Junhui

Date 2015.4.23



GONG, Hua

Date 2015.4.23

COMBINED DECLARATION & ASSIGNMENT	Page 2 of 2
	Title: ARRAY SUBSTRATE AND MANUFACTURING METHOD THEREOF, AND DISPLAY PANEL

马俊超

MA, Junchau

Date 2015.4.23

吴勇

WU, Yong

Date 2015.4.23